

Features

- Operating range V_{CC} = 2.5V to 6V
- Rail-to-rail input and output
- Extended V_{icm} ($V_{DD} - 0.2V$ to $V_{CC} + 0.2V$)
- Capable of driving a 32Ω load resistor
- High stability: 500pF
- Available in SOT23-5 micropackage
- Operating temperature range: -40°C, +125°C

Applications

- Battery-powered applications
- Audio driver (headphone driver)
- Sensor signal conditioning
- Laptop/notebook computers

Description

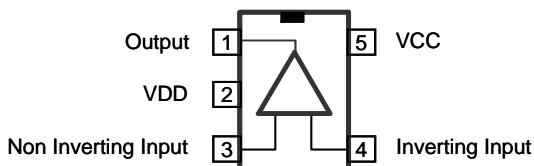
The TSV358 and TSV324 (dual and quad) are low voltage versions of LM358 and LM324 commodity operational amplifiers. TSV321 is the single version. The TSV321/358/324 are able to operate with voltages as low as 2.5V and feature both I/O rail-to-rail.

The common mode input voltage extends 200mV at 25°C beyond the supply voltages while the output voltage swing is within 100mV of each rail with 600 Ohm load resistor. At V_{CC} = 3V, these devices offer 1.3MHz of gain-bandwidth product and provide high output drive capability typically at 80mA-load.

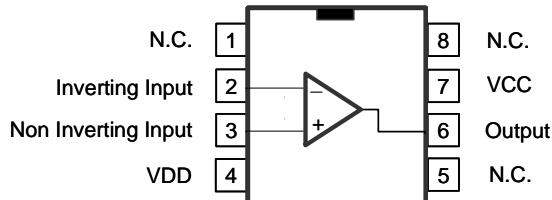
These features make the TSV3xx family ideal for active filters, general purpose low-voltage applications, and general purpose portable devices.

Pin connections (top view)

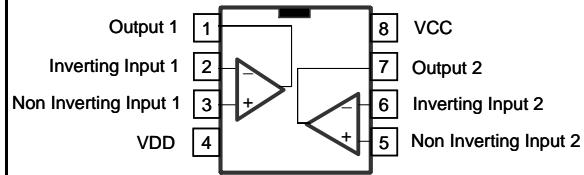
TSV321RLT (SOT23-5)



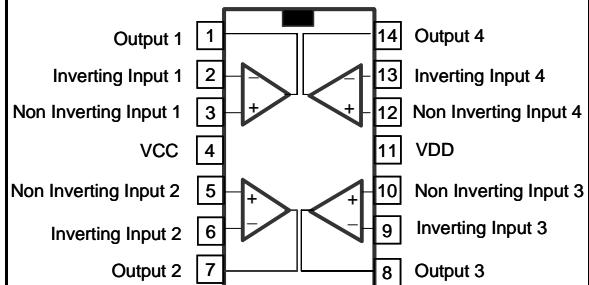
TSV321ID-TSV321IDT (SO-8)



TSV358IST-TSV358ID-TSV358IDT-TSV358IPT
(SO-8, miniSO-8, TSSOP8)



TSV324ID-TSV324IDT-TSV324IPT
(SO-14, TSSOP14)



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1 Absolute maximum ratings and operating conditions

Table 1. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage ⁽¹⁾	7	V
V_{id}	Differential input voltage ⁽²⁾	± 1	V
V_{in}	Input voltage	$V_{DD}-0.3$ to $V_{CC}+0.3$	V
T_{stg}	Storage temperature	-65 to +150	°C
T_j	Maximum junction temperature	150	°C
R_{thja}	Thermal resistance junction to ambient ^{(3) (4)}	250 125 103 120 100 190	°C/W
R_{thjc}	Thermal resistance junction to case	81 40 31 37 32 39	°C/W
ESD	HBM: human body model ⁽⁵⁾	2	kV
	MM: machine model ⁽⁶⁾	200	V
	CDM: charged device model ⁽⁷⁾	1.5	kV
	Latch-up immunity	200	mA
	Lead temperature (soldering, 10s)	250	°C
	Output short-circuit duration	See note ⁽⁸⁾	

1. All voltages values, except differential voltage are with respect to network terminal.
2. Differential voltages are the non-inverting input terminal with respect to the inverting input terminal. If $V_{id} > \pm 1V$, the maximum input current must not exceed $\pm 1\text{mA}$. When $V_{id} > \pm 1V$, an input series resistor must be added to limit input current.
3. Short-circuits can cause excessive heating and destructive dissipation.
4. R_{th} are typical values.
5. Human body model: 100pF discharged through a 1.5kΩ resistor between two pins of the device, done for all couples of pin combinations with other pins floating.
6. Machine model: a 200pF cap is charged to the specified voltage, then discharged directly between two pins of the device with no external series resistor (internal resistor $< 5\Omega$), done for all couples of pin combinations with other pins floating.
7. Charged device model: all pins plus package are charged together to the specified voltage and then discharged directly to the ground.
8. Short-circuits from the output to V_{CC} can cause excessive heating. The maximum output current is approximately 80mA, independent of the magnitude of V_{CC} . Destructive dissipation can result from simultaneous short-circuits on all amplifiers.

Table 2. Operating conditions

Symbol	Parameter	Value	Unit
V_{CC}	Supply voltage	2.5 to 6	V
V_{icm}	Common mode input voltage range $T_{op} = 25^\circ\text{C}, 2.5 \leq V_{CC} \leq 6\text{V}$ $T_{min} < T_{op} < T_{max}, 2.5 \leq V_{CC} \leq 5.5\text{V}$	$V_{DD} - 0.2$ to $V_{CC} + 0.2$ V_{DD} to V_{CC}	V
T_{oper}	Operating free air temperature range	-40 to + 125	°C

2 Electrical characteristics

Table 3. Electrical characteristics at $V_{CC} = +3V$, $V_{DD} = 0V$, R_L , C_L connected to $V_{CC}/2$, and $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
V_{io}	Input offset voltage	$V_{icm} = V_{out} = V_{CC}/2$ TSV321/358/324 $T_{min} < T_{op} < T_{max}$ TSV321A/358A/324A $T_{min} < T_{op} < T_{max}$		0.2 0.1	3 1 3	mV
ΔV_{io}	Input offset voltage drift			2		$\mu V/\text{ }^\circ C$
I_{io}	Input offset current ⁽¹⁾	$V_{icm} = V_{out} = V_{CC}/2$ $T_{min} \leq T_{amb} \leq T_{max}$		3	30 60	nA
I_{ib}	Input bias current ⁽¹⁾	$V_{icm} = V_{out} = V_{CC}/2$ $T_{min} \leq T_{amb} \leq T_{max}$		40	125 150	nA
CMR	Common mode rejection ratio 20 log ($\Delta V_{ic}/\Delta V_{io}$)	$0 \leq V_{icm} \leq V_{CC}$, $V_{out} = V_{CC}/2$	60	80		dB
A_{vd}	Large signal voltage gain	$V_{out} = 0.5V$ to $2.5V$ $R_L = 2k\Omega$ $R_L = 600\Omega$	80 74	92 95		dB
V_{OH}	High level output voltage	$V_{id} = 100mV$ $R_L = 2k\Omega$ $R_L = 600\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$, $R_L = 2k\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$, $R_L = 600\Omega$	2.82 2.80 2.82 2.80	2.95 2.95		V
V_{OL}	Low level output voltage	$V_{id} = -100mV$ $R_L = 2k\Omega$ $R_L = 600\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$, $R_L = 2k\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$, $R_L = 600\Omega$		88 115	120 160 120 160	mV
I_o	Output source current	$V_{id} = 100mV$, $V_O = V_{DD}$	20	80		mA
	Output sink current	$V_{id} = -100mV$, $V_O = V_{CC}$	20	80		
I_{CC}	Supply current (per amplifier)	$A_{VCL} = 1$, no load $T_{min} \leq T_{amb} \leq T_{max}$		420	650 690	μA
GBP	Gain bandwidth product	$R_L = 10k\Omega$ $C_L = 100pF$, $f = 100kHz$	1	1.3		MHz
SR	Slew rate	$R_L = 10k\Omega$ $C_L = 100pF$	0.42	0.6		$V/\mu s$
ϕ_m	Phase margin	$C_L = 100pF$		53		Degrees
en	Input voltage noise			27		nV/\sqrt{Hz}
THD	Total harmonic distortion			0.01		%

1. Maximum values include unavoidable inaccuracies of the industrial tests.

Table 4. Electrical characteristics at $V_{CC} = +5V$, $V_{DD} = 0V$, R_L , C_L connected to $V_{CC}/2$, and $T_{amb} = 25^\circ C$ (unless otherwise specified)

Symbol	Parameter	Conditions	Min.	Typ.	Max.	Unit
V_{io}	Input offset voltage	$V_{icm} = V_{out} = V_{CC}/2$ TSV321/358/324 $T_{min} < T_{op} < T_{max}$ TSV321A/358A/324A $T_{min} < T_{op} < T_{max}$		0.2 0.1	3 1 3	mV
ΔV_{io}	Input offset voltage drift			2		$\mu V/\text{ }^\circ C$
I_{io}	Input offset current ⁽¹⁾	$V_{icm} = V_{out} = V_{CC}/2$ $T_{min} \leq T_{amb} \leq T_{max}$		3	30 60	nA
I_{ib}	Input bias current ⁽¹⁾	$V_{icm} = V_{out} = V_{CC}/2$ $T_{min} \leq T_{amb} \leq T_{max}$		70	130 150	nA
CMR	Common mode rejection ratio 20 log ($\Delta V_{ic}/\Delta V_{io}$)	$0 \leq V_{icm} \leq V_{CC}$, $V_{out} = V_{CC}/2$	65	85		dB
SVR	Supply voltage rejection ratio 20 log ($\Delta V_{CC}/\Delta V_{io}$)	$V_{CC} = 2.5$ to $5V$	70	90		dB
A_{vd}	Large signal voltage gain	$V_{out} = 0.5V$ to $4.5V$ $R_L = 2k\Omega$ $R_L = 600\Omega$	83 77	92 85		dB
V_{OH}	High level output voltage	$V_{id} = 100mV$ $R_L = 2k\Omega$ $R_L = 600\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$, $R_L = 2k\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$, $R_L = 600\Omega$	4.80 4.75 4.80 4.75	4.95 4.90		V
V_{OL}	Low level output voltage	$V_{id} = -100mV$ $R_L = 2k\Omega$ $R_L = 600\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$, $R_L = 2k\Omega$ $T_{min} \leq T_{amb} \leq T_{max}$, $R_L = 600\Omega$		88 115	130 188 130 188	mV
I_o	Output source current	$V_{id} = 100mV$, $V_O = V_{DD}$	20	80		mA
	Output sink current	$V_{id} = -100mV$, $V_O = V_{CC}$	20	80		
I_{cc}	Supply current (per amplifier)	$A_{VCL} = 1$, no load $T_{min} \leq T_{amb} \leq T_{max}$		500	835 875	μA
GBP	Gain bandwidth product	$R_L = 10k\Omega$ $C_L = 100pF$, $f = 100kHz$	1	1.4		MHz
SR	Slew rate	$R_L = 10k\Omega$ $C_L = 100pF$	0.42	0.6		$V/\mu s$
ϕ_m	Phase margin	$C_L = 100pF$		55		Degrees
en	Input voltage noise			27		nV/\sqrt{Hz}
THD	Total harmonic distortion			0.01		%

1. Maximum values include unavoidable inaccuracies of the industrial tests.

Figure 1. Supply current/amplifier vs. supply voltage

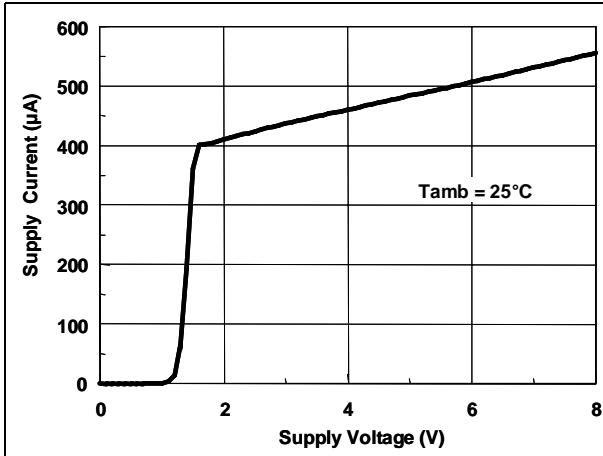


Figure 2. Supply current/amplifier vs. temperature

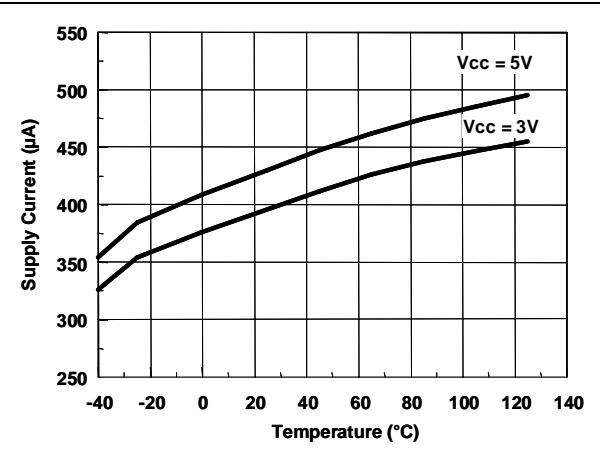


Figure 3. Output power vs. supply voltage

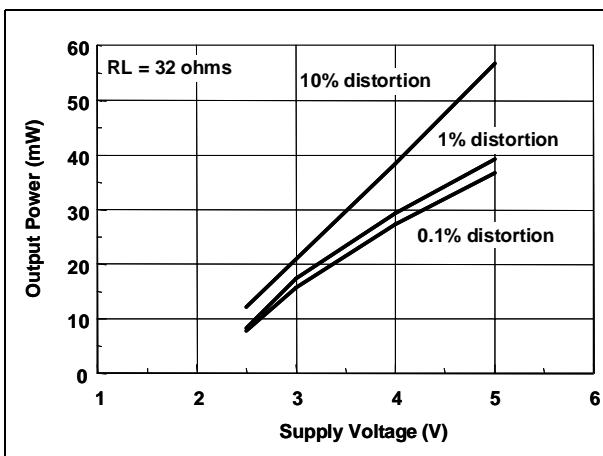


Figure 4. Input offset voltage drift vs. temperature

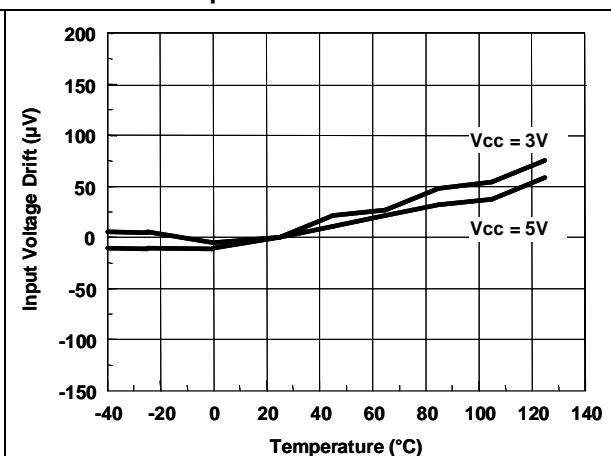


Figure 5. Input bias current vs. temperature

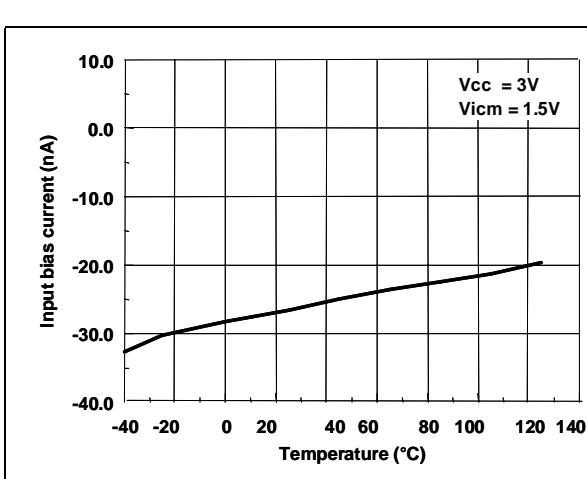


Figure 6. Open loop gain vs. temperature at $V_{CC} = 5V$

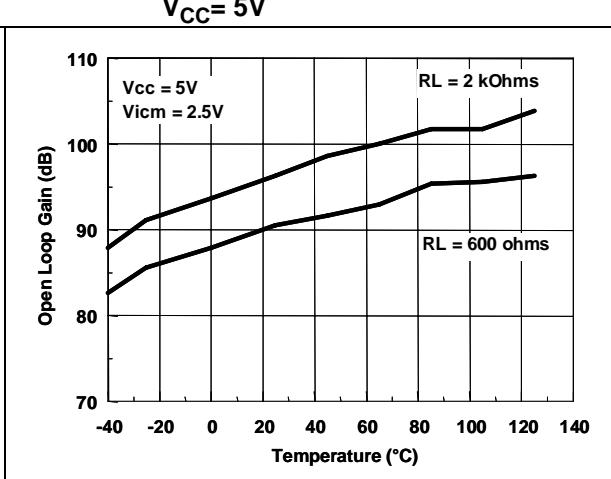


Figure 7. Open loop gain vs. temperature at $V_{CC} = 3V$

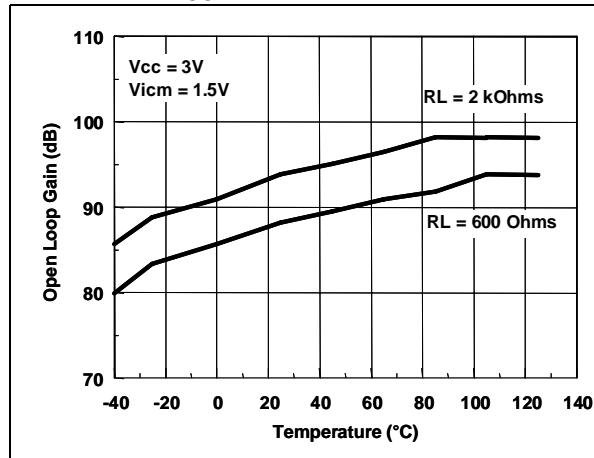


Figure 8. High level output voltage vs. temperature

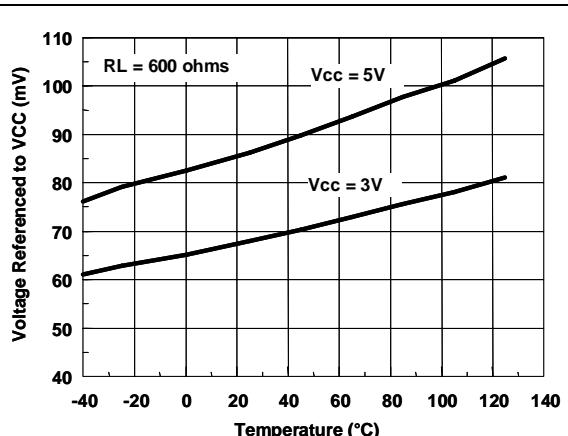


Figure 9. Low level output voltage vs. temperature

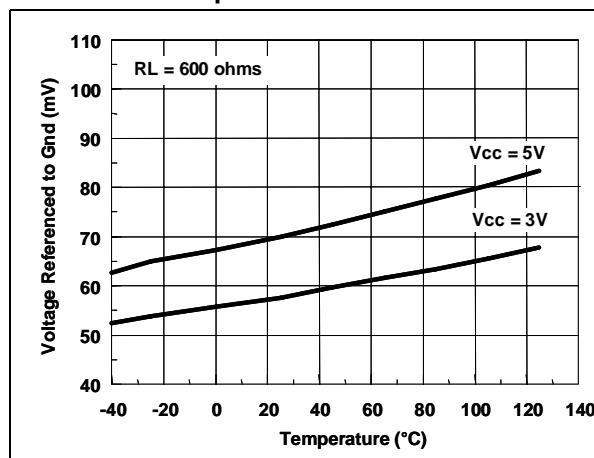


Figure 10. Output current vs. temperature at $V_{CC} = 5V$

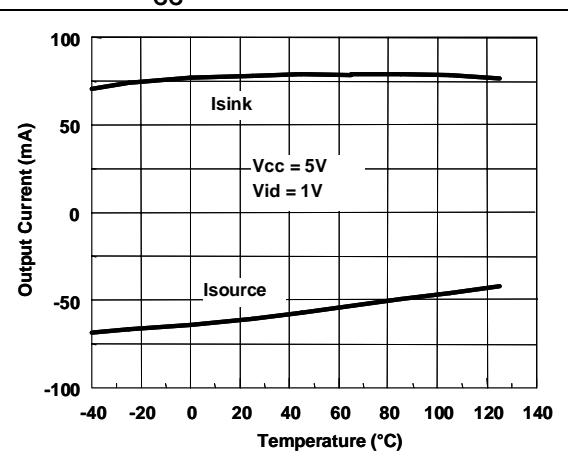


Figure 11. Output current vs. temperature at $V_{CC} = 3V$

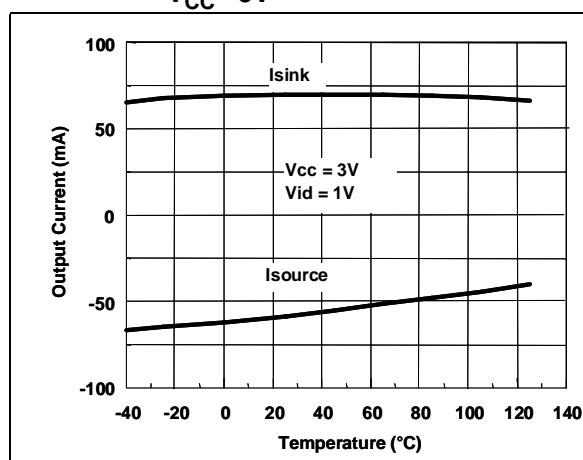


Figure 12. Output current vs. output voltage at $V_{CC} = 5V$

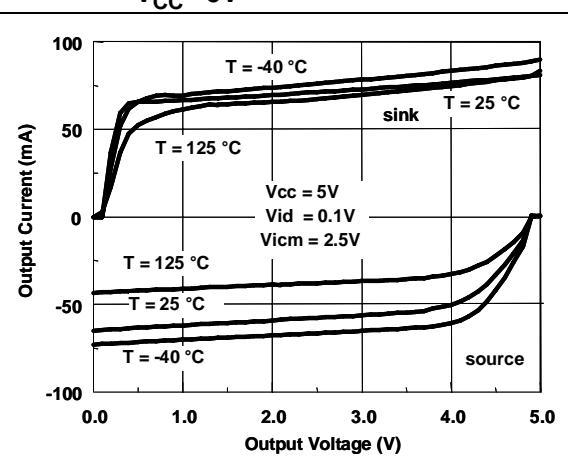


Figure 13. Output current vs. output voltage at $V_{CC} = 3V$

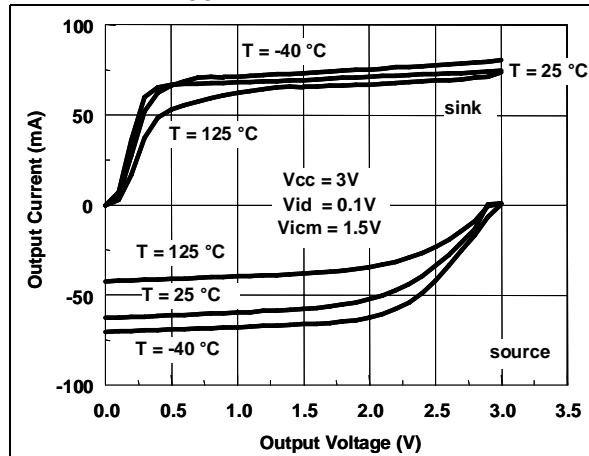


Figure 14. Gain and phase vs. frequency at $V_{CC} = 5V$

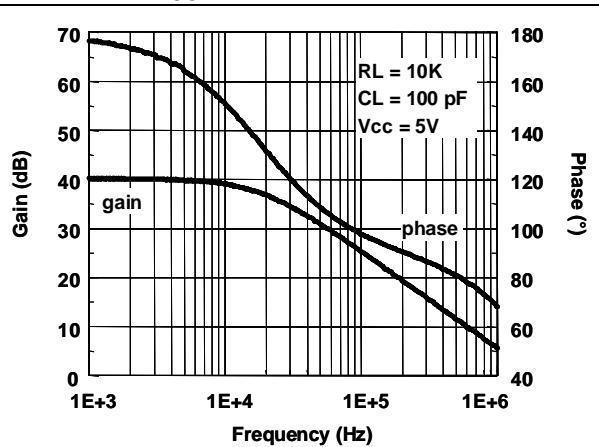


Figure 15. Gain and phase vs. frequency at $V_{CC} = 3V$

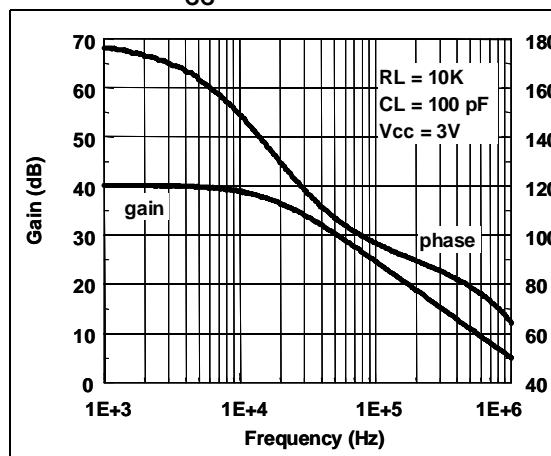


Figure 16. Slew rate vs. temperature at $V_{CC} = 5V$

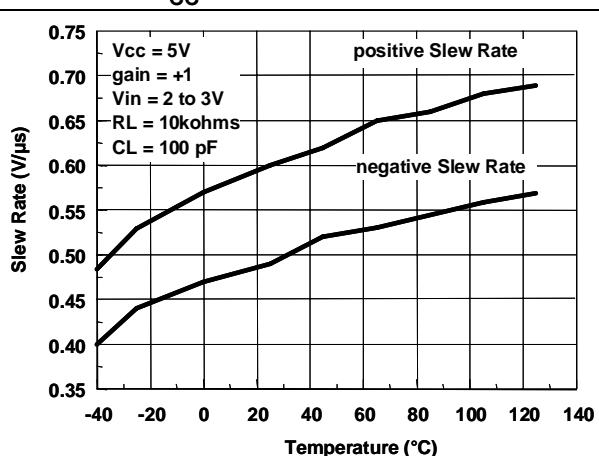


Figure 17. Slew rate vs. temperature at $V_{CC} = 3V$

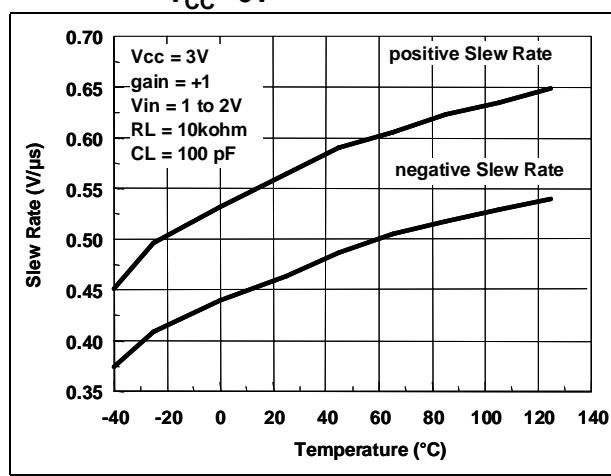
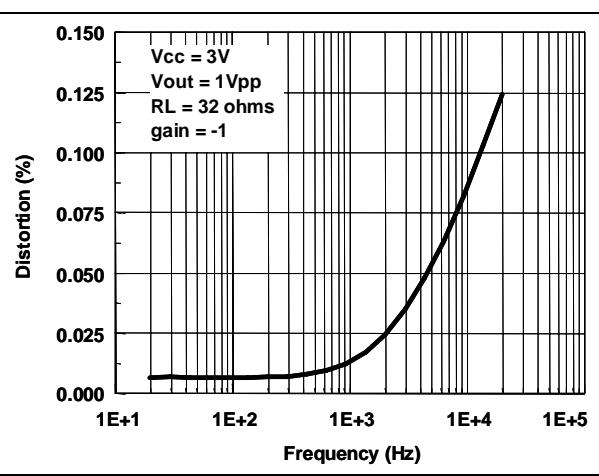


Figure 18. Distortion vs. frequency



3 Package information

In order to meet environmental requirements, STMicroelectronics offers these devices in ECOPACK® packages. These packages have a lead-free second level interconnect. The category of second level interconnect is marked on the package and on the inner box label, in compliance with JEDEC Standard JESD97. The maximum ratings related to soldering conditions are also marked on the inner box label. ECOPACK is an STMicroelectronics trademark. ECOPACK specifications are available at: www.st.com.

3.1 SO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.069
A1	0.10		0.25	0.004		0.010
A2	1.25			0.049		
b	0.28		0.48	0.011		0.019
c	0.17		0.23	0.007		0.010
D	4.80	4.90	5.00	0.189	0.193	0.197
H	5.80	6.00	6.20	0.228	0.236	0.244
E1	3.80	3.90	4.00	0.150	0.154	0.157
e		1.27			0.050	
h	0.25		0.50	0.010		0.020
L	0.40		1.27	0.016		0.050
k	1°		8°	1°		8°
ccc			0.10			0.004

The figure contains three technical drawings of an SO-8 package. The top drawing is a top-down view showing the footprint with lead numbers 1 through 8. Dimensions include lead pitch 'e', lead height 'h', and lead thickness 'A1'. The middle drawing is a side view showing the package's height 'H', lead thickness 'A1', lead height 'A2', lead width 'b', and lead spacing 'D'. The bottom drawing is a cross-sectional view showing the seating plane 'C', the gage plane at 0.25 mm, lead length 'L', and lead thickness 'L1'.

3.2 TSSOP8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002		0.006
A2	0.80	1.00	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.008
D	2.90	3.00	3.10	0.114	0.118	0.122
E	6.20	6.40	6.60	0.244	0.252	0.260
E1	4.30	4.40	4.50	0.169	0.173	0.177
e		0.65			0.0256	
k	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030
L1		1			0.039	
aaa		0.1			0.004	

The figure contains three technical drawings of the TSSOP8 package:

- Top View:** Shows the package outline with pins numbered 1 through 8. Pin 1 is identified by a circle at the bottom left. Dimensions shown are D, E, and e.
- Side Cross-Section:** Shows the package thickness (A) and lead height (A1). Other dimensions include b, c, and L1. A note specifies a gage plane at 0.25 mm (0.01 inch).
- Pin 1 Identification:** A callout shows the location of Pin 1 on the top view drawing.

3.3 MiniSO-8 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.1			0.043
A1	0.05	0.10	0.15	0.002	0.004	0.006
A2	0.78	0.86	0.94	0.031	0.034	0.037
b	0.25	0.33	0.40	0.010	0.013	0.016
c	0.13	0.18	0.23	0.005	0.007	0.009
D	2.90	3.00	3.10	0.114	0.118	0.122
E	4.75	4.90	5.05	0.187	0.193	0.199
E1	2.90	3.00	3.10	0.114	0.118	0.122
e		0.65			0.026	
K	0°		6°	0°		6°
L	0.40	0.55	0.70	0.016	0.022	0.028
L1			0.10			0.004

PIN 1 IDENTIFICATION

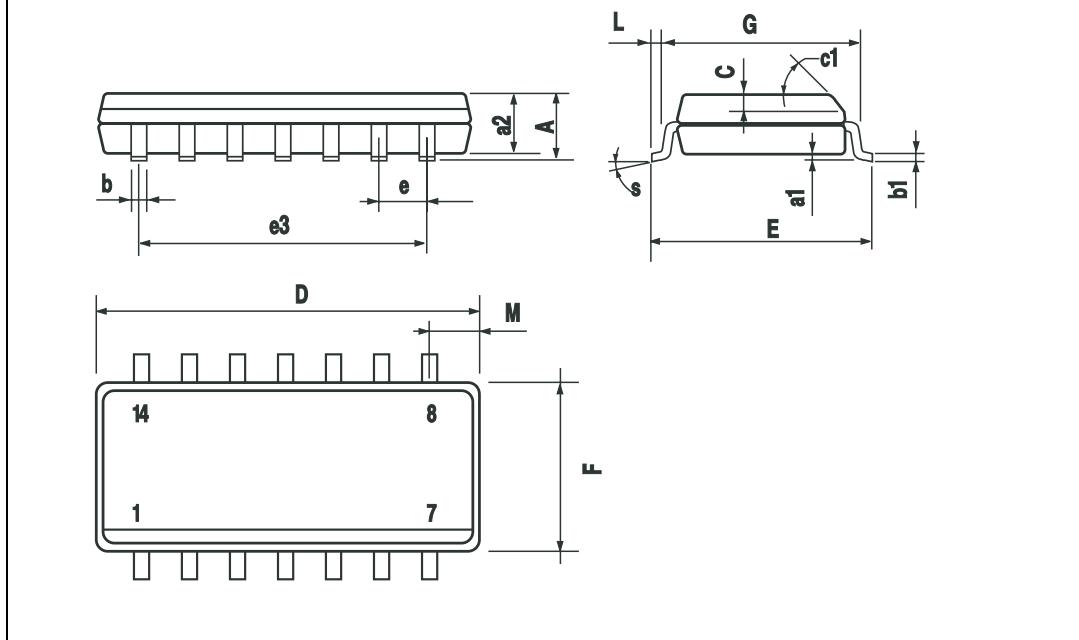
SEATING PLANE

GAGE PLANE

0.025 mm
.010 inch

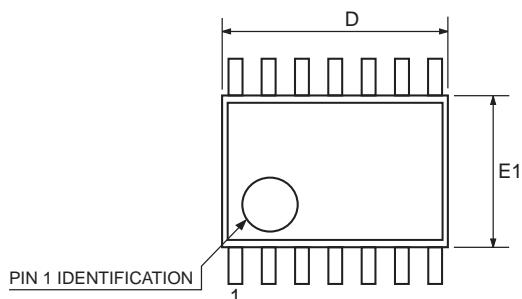
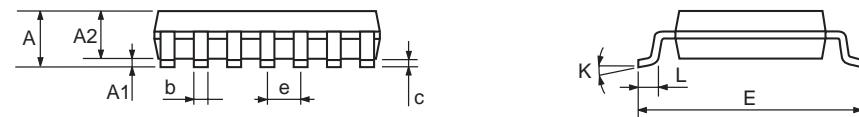
3.4 SO-14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.75			0.068
a1	0.1		0.2	0.003		0.007
a2			1.65			0.064
b	0.35		0.46	0.013		0.018
b1	0.19		0.25	0.007		0.010
C		0.5			0.019	
c1	45° (typ.)					
D	8.55		8.75	0.336		0.344
E	5.8		6.2	0.228		0.244
e		1.27			0.050	
e3		7.62			0.300	
F	3.8		4.0	0.149		0.157
G	4.6		5.3	0.181		0.208
L	0.5		1.27	0.019		0.050
M			0.68			0.026
S	8° (max.)					



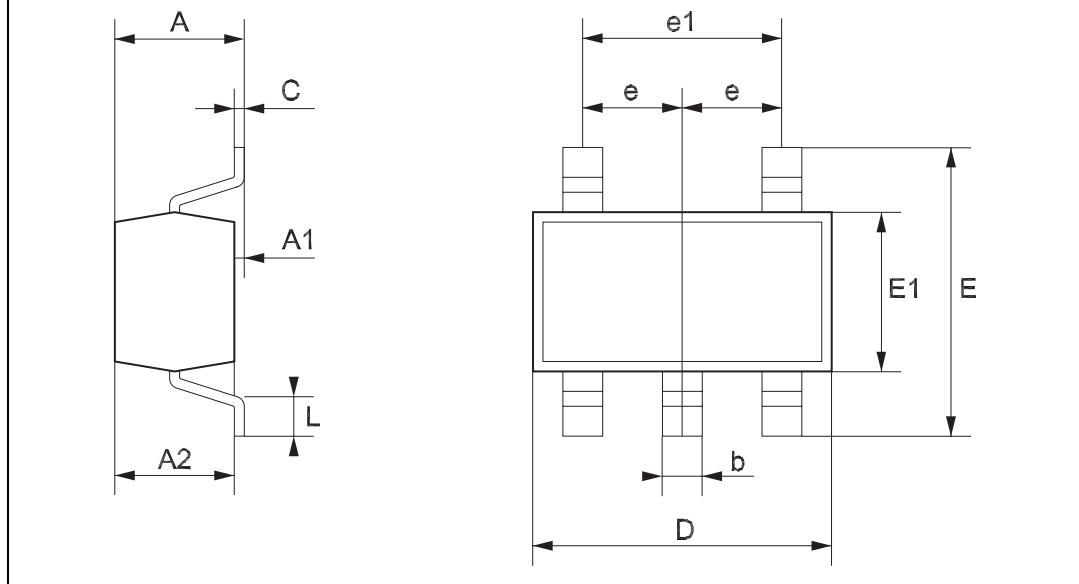
3.5 TSSOP14 package mechanical data

Ref.	Dimensions					
	Millimeters			Inches		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A			1.2			0.047
A1	0.05		0.15	0.002	0.004	0.006
A2	0.8	1	1.05	0.031	0.039	0.041
b	0.19		0.30	0.007		0.012
c	0.09		0.20	0.004		0.0089
D	4.9	5	5.1	0.193	0.197	0.201
E	6.2	6.4	6.6	0.244	0.252	0.260
E1	4.3	4.4	4.48	0.169	0.173	0.176
e		0.65 BSC			0.0256 BSC	
K	0°		8°	0°		8°
L	0.45	0.60	0.75	0.018	0.024	0.030



3.6 SOT23-5 package mechanical data

Ref.	Dimensions					
	Millimeters			Mils		
	Min.	Typ.	Max.	Min.	Typ.	Max.
A	0.90		1.45	35.4		57.1
A1	0.00		0.15	0.00		5.9
A2	0.90		1.30	35.4		51.2
b	0.35		0.50	13.7		19.7
C	0.09		0.20	3.5		7.8
D	2.80		3.00	110.2		118.1
E	2.60		3.00	102.3		118.1
E1	1.50		1.75	59.0		68.8
e		0.95			37.4	
e1		1.9			74.8	
L	0.35		0.55	13.7		21.6



4 Ordering information

Table 5. Order codes

Part number	Temperature range	Package	Packaging	Marking
TSV321RILT	-40°C to +125°C	SOT23-5	Tape & reel	K174
TSV321RAILT				K178
TSV321RIYLT ⁽¹⁾		SOT23-5 (Automotive grade level)	Tape & reel	K179
TSV321RAIYLT ⁽¹⁾				K187
TSV321ID/IDT		SO-8	Tube or tape & reel	V321ID
TSV321IYD/IYDT ⁽¹⁾		SO-8 (Automotive grade level)	Tube or tape & reel	V321Y
TSV321AID/IDT		SO-8	Tube or tape & reel	V321AI
TSV358ID/IDT		SO-8	Tube or tape & reel	V358ID
TSV358AID/IDT				V358AID
TSV358IYD/IYDT ⁽¹⁾		SO-8 (Automotive grade level)	Tube or tape & reel	V358YD
TSV358AIYD/AIYDT ⁽¹⁾				V358AY
TSV358IPT		TSSOP8 (Thin shrink outline package)	Tape & reel	V358I
TSV358AIPT		V358A		
TSV358IYPT ⁽¹⁾		TSSOP8 (Automotive grade level)	Tape & reel	V358Y
TSV358AIYPT ⁽¹⁾				V58AY
TSV358IST		MiniSO-8	Tape & reel	K175
TSV358AIST				K184
TSV324ID/IDT		SO-14	Tube or tape & reel	V324ID
TSV324AID/AIDT				V324AI
TSV324IYD/IYDT ⁽¹⁾		SO-14 (Automotive grade level)	Tube or tape & reel	V324YD
TSV324AIYD/AIYDT ⁽¹⁾				V324AY
TSV324IPT		TSSOP14 (Thin shrink outline package)	Tape & reel	V324IP
TSV324AIPT				V324A
TSV324AIYPT ⁽¹⁾		TSSOP14 (Automotive grade level)	Tape & reel	V324AY
TSV324IYPT ⁽¹⁾				V324Y

1. Qualified and characterized according to AEC Q100 and Q003 or equivalent, advanced screening according to AEC Q001 & Q 002 or equivalent.

5 Revision history

Date	Revision	Changes
2-Aug-2005	1	First release - Products in full production.
20-Sep-2005	2	Addition of TS321A/TS324A/TS358A data in tables in Section 2: Electrical characteristics on page 5 . Minor formatting and grammatical changes.
7-Dec-2005	3	Missing PPAP references inserted see Section 4: Ordering information on page 17 .
28-Jun-2007	4	Correction made on output drive capability, 80mA in description on cover page. SVR measurement conditions inserted in electrical characteristics tables. Offset voltage limit in temperature added in Section 2: Electrical characteristics on page 5 . Correction made on Input Bias Current typical value in Section 2: Electrical characteristics on page 5 . Captions of electrical characteristics figures updated. Automotive grade order codes added to Section 4: Ordering information on page 17 .

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